### imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### Features

- Uniform light output.
- Low power consumption.
- Long life-solid state reliability.
- RoHS compliant.

#### T-1 3/4 (5mm) FULL COLOR LED LAMP

Part Number: WP154A4SUREQBFZGC

Hyper Red Blue Green

#### Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The Blue source color devices are made with InGaN Light Emitting Diode.

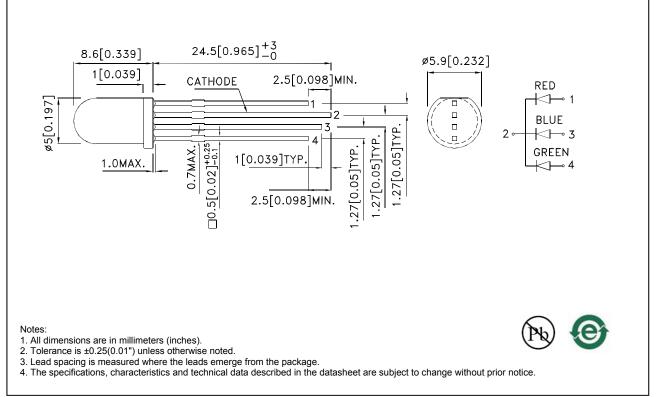
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### Package Dimensions



SPEC NO: DSAJ8687 APPROVED: WYNEC REV NO: V.4A CHECKED: Allen Liu DATE: FEB/03/2013 DRAWN: Y.Liu

PAGE: 1 OF 8 ERP: 1101026910

Selection Guide					
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
WP154A4SUREQBFZGC	Hyper Red (AlGaInP)	Water Clear	650	1300	50°
			*200	*400	
	Blue (InGaN)		400	900	
			*400	*900	
	Green (InGaN)		1000	1700	
			*1000	*1700	

Notes:

01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.
\*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Blue Green	645 460 515		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red Blue Green	630 465 525		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Blue Green	25 25 30		nm	IF=20mA
С	Capacitance	Hyper Red Blue Green	45 100 45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Blue Green	1.9 3.3 3.3	2.5 4 4.1	V	I⊧=20mA
lr	Reverse Current	Hyper Red Blue Green		10 50 50	uA	Vr=5V

Notes:

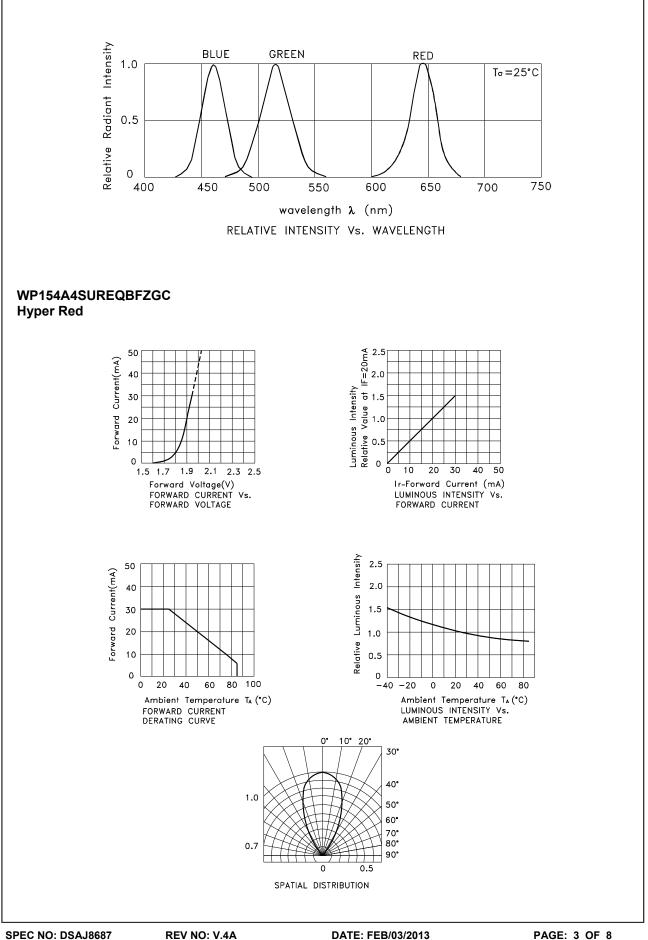
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. 3.Wavelength value is traceable to the CIE127-2007 compliant national standards.

#### Absolute Maximum Ratings at TA=25°C

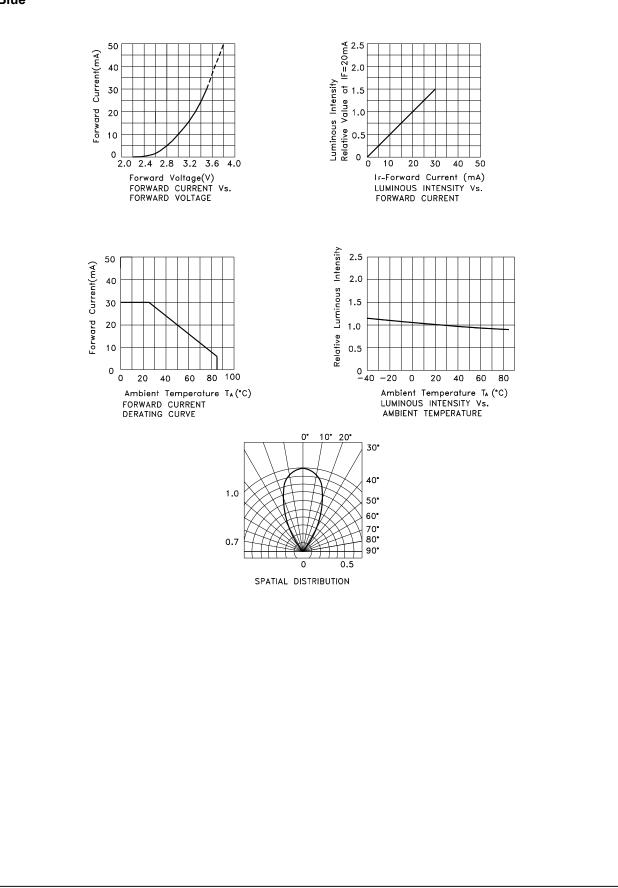
Hyper Red	Blue	Green	Units		
75	120	102.5	mW		
30	30	25	mA		
200	150	150	mA		
	5				
-40°C To +85°C					
260°C For 3 Seconds					
260°C For 5 Seconds					
	75 30	75 120   30 30   200 150   5 -40°C To +8   260°C For 3 Set	75 120 102.5   30 30 25   200 150 150   5   -40°C To +85°C   260°C For 3 Seconds		

1.1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.

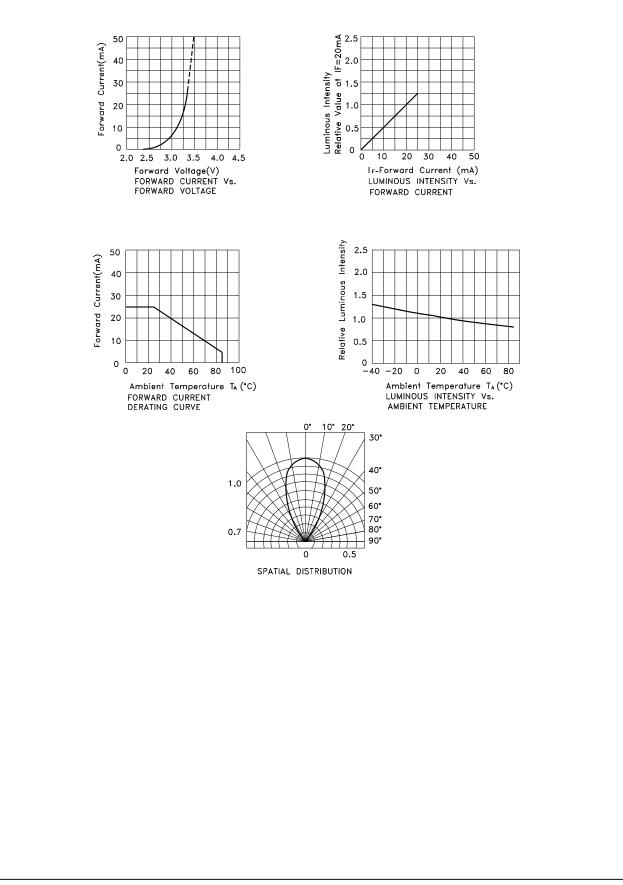
DATE: FEB/03/2013 DRAWN: Y.Liu

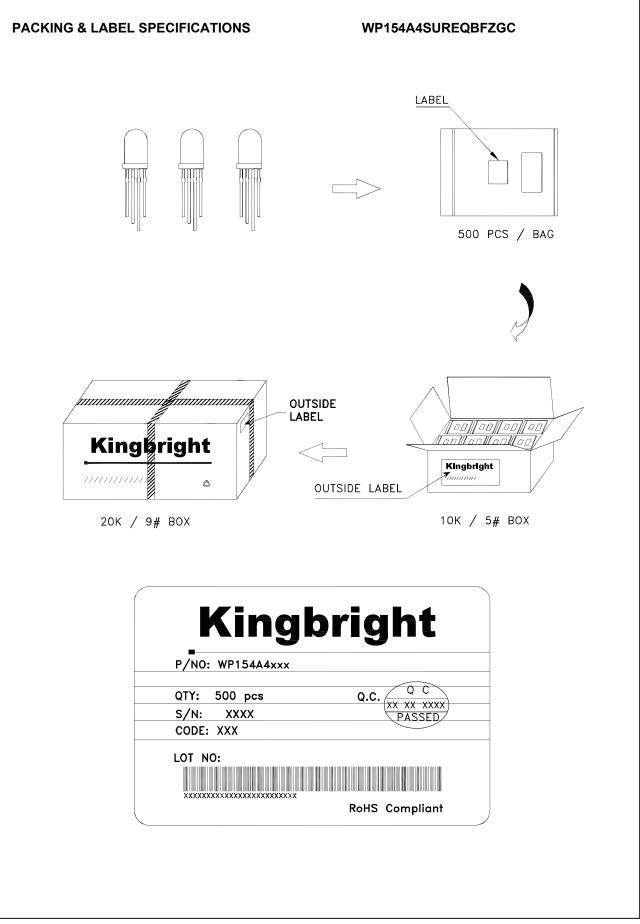


Blue



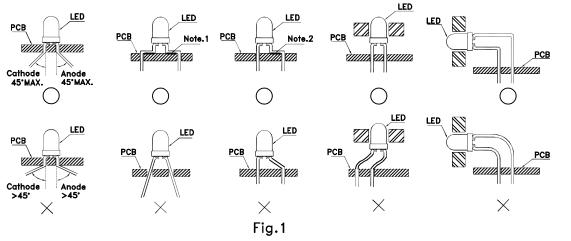
Green





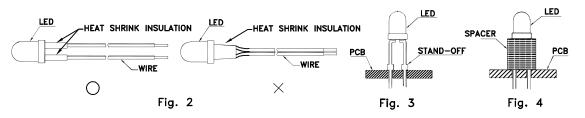
### PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)

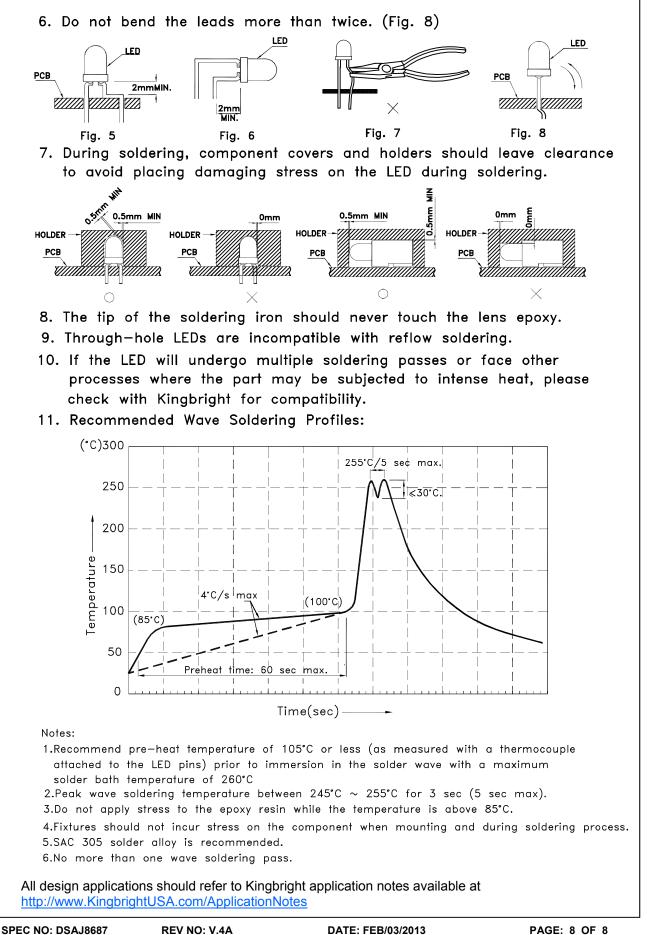


" $\bigcirc$  " Correct mounting method "imes" Incorrect mounting method

- When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



CHECKED: Allen Liu

DATE: FEB/03/2013 DRAWN: Y.Liu